


NOTES

\*Material:

- 1.Body: PPS UL 94V-0 Rated, Color:Black;
- 2.Cover: LCP UL 94V-0 Rated, Color:Black;
- 3.Contact: Phosphor Bronze;
- 4.Contact Plating: Gold Plating Over Nickel on Contact Area, Tin Plating on Solder Tail.

\*Specification:

- 1.Current Rating: 0.5 AMP. Max.;
- 2.Dielectric Withstanding Voltage: 500V AC R.M.S For One Minute;
- 3.Insulation Resistance: 1000 M Ohms Min. AT 500V AC;
- 4.Contact Resistance: 30 M Ohms Max.;
- 5.Operating Temperature: -25°C to +85°C;
- 6.Processing Temp: 245°C for 30~60 Seconds Max.;
- 7.Durability: 5000 Cycles.

|                        |  |  |                   |
|------------------------|--|--|-------------------|
| RoHS Compliant         |  |  <b>玄茂科技股份有限公司</b><br><b>HSUAN MAO TECHNOLOGY CO., LTD.</b> |                   |
| APPD. 核准<br>Betty      | <br>TOLERANCES ARE<br>.X ± 0.38<br>.XX ± 0.25<br>.XXX ± 0.20<br>AWG | PART NAME 品名<br>SIM CARD BLOCK TYPE HINGED COVER 6P<br>H:2.3mm GOLD 3U" PLATING WITHOUT POST<br>BLACK INSULATOR ROHS                             |                   |
| DWG. 製圖<br>Betty       |  | SCALE 比例<br>參考   | SIZE. 紙張尺寸<br>A 4 |
| DATE 制表日<br>2012/02/21 | UNIT 單位<br>MM  | PAGE 張數<br>1 OF 1  | REV. 版次<br>B      |
|                        |  | PART NO. 料號<br>C0612-06DAJBB0R   |                   |